L Number	Hits	Search Text	DB	Time stamp
–	379	156/345.12 156/345.17 156/345.18	USPAT	2004/05/18 12:05
–	816	134/113	USPAT	2004/05/18 15:00
–	110	156/345.21	USPAT	2004/05/18 15:00
–	2	(("6051499") or ("5709593")).PN.	USPAT	2004/05/18 15:56
–	0	("polish$3orplanariza$4").PN.	USPAT	2004/05/18 15:57
–	0	("polish$3orplanariza$4").PN.	USPAT	2004/05/18 15:57
–	115896	polish$3 or planariza$4	USPAT	2004/05/18 15:58
–	17226	chemical adj mechanical adj (polish$3 or planariza$4)	USPAT	2004/05/18 15:58
–	16969	(chemical adj mechanical adj (polish$3 or planariza$4)) and (substrate wafer)	USPAT	2004/05/18 16:00